

January 2008

Lead Free

- Pletronics' SM9T Series is a miniature low profile surface mount crystal.
- Package is ideal for automated surface mount assembly and reflow practices.
- Tape and Reel packaging

- 16 MHz to 80 MHZ
- 2.0 x 2.5 mm 4 pad
- AT Cut Fundamental Crystal
- · Ideal for use in hand held consumer products

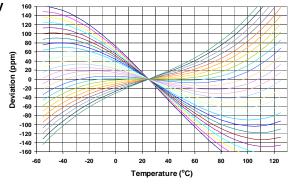
Pletronics Inc. certifies this device is in accordance with the RoHS 6/9 (2002/95/EC) and WEEE (2002/96/EC) directives.

Pletronics Inc. guarantees the device does not contain the following: Cadmium, Hexavalent Chromium, Lead, Mercury, PBB's, PBDE's Weight of the Device: 0.04 grams Moisture Sensitivity Level: 1 As defined in J-STD-020C Second Level Interconnect code: e4

Electrical Specification:

Item	Min	Max	Unit	Condition
Frequency Range	16	80	MHZ	
Calibration Frequency Tolerance	50	150	ppm	at +25°C \pm 3°C, see part number for options
Frequency Stability	50	150	ppm	see part number for available options
Equivalent Series Resistance	-	80	Ohms	to 21 MHZ
(ESR)	-	70	Ohms	to 31 MHZ
	-	50	Ohms	above 31 MHz
Drive Level	-	100	μW	use 10 µW for testing
Shunt Capacitance (C0)	-	5	pF	Pad to Pad capacitance
Aging at 25°C <u>+</u> 3°C	-5	+5	ppm /Yr	for the first year at +25°C ± 3°C
	-2	+2	ppm /Yr	after the first year at +25°C ± 3°C
Operating Temperature Range	-40	+125	°C	see part number for available specified tolerance range options
Storage Temperature Range	-55	+125	°C	

AT Cut Crystal Frequency versus Temperature Typical Performance:



Product information is current as of publication date. The product conforms to specifications per the terms of the Pletronics standard warranty. Production processsing does not necessarily include testing of all parameters.



Part N	umk	ber:							
SM9T	-8	-25.0M	-50	Н	1	G	G	-XX	See chart below for available options
									Internal code or blank
									Highest Specified Operating Temperature $A = 40^{\circ}C$ $G = 70^{\circ}C$ $N = 100^{\circ}C$ $B = 45^{\circ}C$ $H = 75^{\circ}C$ $P = 105^{\circ}C$ $C = 50^{\circ}C$ $J = 80^{\circ}C$ $R = 110^{\circ}C$ $D = 55^{\circ}C$ $K = 85^{\circ}C$ $S = 115^{\circ}C$ $E = 60^{\circ}C$ $L = 90^{\circ}C$ $T = 120^{\circ}C$ $F = 65^{\circ}C$ $M = 95^{\circ}C$ $U = 125^{\circ}C$
									Lowest Specified Operating Temperature $A = +10^{\circ}C$ $F = -15^{\circ}C$ $L = -40^{\circ}C$ $B = +5^{\circ}C$ $G = -20^{\circ}C$ $M = -45^{\circ}C$ $C = 0^{\circ}C$ $H = -25^{\circ}C$ $N = -50^{\circ}C$ $D = -5^{\circ}C$ $J = -30^{\circ}C$ $P = -55^{\circ}C$ $E = -10^{\circ}C$ $K = -35^{\circ}C$
									Fundamental mode AT cut crystal
									Frequency Stability See chart below
									Calibration Frequency Tolerance (Typ. Values shown) $20 = \pm 20 \text{ ppm at } 25^{\circ}\text{C} \pm 3^{\circ}\text{C}$ $50 = \pm 50 \text{ ppm at } 25^{\circ}\text{C} \pm 3^{\circ}\text{C}$ (Standard)
									Frequency in MHZ
									Cload in pF Parallel Resonance from 06 to 32 pF, 8 pF is standard -or- SR = Series Resonance
									Model Number

Current production ranges are shown below.

				Avai	ilable Frequ	ency Stabili	ty versus Te	mperature i	n ppm		
Operating]	Α	В	С	D	E	F	G	Н	J	K
Temperature Range	CODE	± 3.0	± 5.0	± 8.0	<u>+</u> 10	<u>+</u> 15	<u>+</u> 20	<u>+</u> 30	<u>±</u> 50	<u>+</u> 100	<u>+</u> 150
0 to +45°C	СВ								•	•	•
0 to +50°C	CC								•	•	•
0 to +60°C	CE								•	•	•
0 to +70°C	CG								STD	٠	•
-10 to +50°C	EC								•	•	•
-10 to +60°C	EE								•	•	•
-10 to +75°C	EH								•	•	•
-20 to +70°C	GG								•	٠	•
-20 to +75°C	GH										
-30 to +75°C	JH										
-30 to +80°C	JJ										
-30 to +85°C	JK										
-35 to +80°C	KJ										
-40 to +85°C	LK										



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Marking and Packing Information

The part will be marked **PFFM YMDx**

- Marking consists of the frequency "FF" which will be truncated to the first two digits due to package size.
- Date code consists of Year, Month and Day (see codes below)
- The x is an internal PLE production code
- Orientation of marking may be mixed on the tape
- Traceability of part is lost once removed from reel

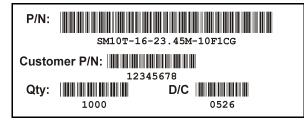
Codes for Date Code (Month Year)

Code	6	7	8	9	0	1	2
Year	2006	2007	2008	2009	2010	2011	2012

ſ	Code	Α	В	С	D	E	F	G	н	J	К	L	М
	Month	JAN	FEB	MAR	APR	MAY	JUN	JUL	AUG	SEP	OCT	NOV	DEC

Package Labeling

Label is 1" x 2.6" (25.4mm x 66.7mm) Font is Courier New Bar code is 39-Full ASCII (Label will read SM9T) Label is 1" x 2.6" (25.4mm x 66.7mm) Font is Arial



RoHS Compliant

2nd LvL Interconnect

Category=e4

Max Safe Temp=260C for 10s 2X Max

Reliability: Environmental Compliance

Parameter	Condition
Mechanical Shock	MIL-STD-883 Method 2002, Condition B
Vibration	MIL-STD-883 Method 2007, Condition A
Solderability	MIL-STD-883 Method 2003
Thermal Shock	MIL-STD-883 Method 1011, Condition A



Inches

0.022

0.004

0.028

0.028

0.035

0.004

0.079 ± 0.004

0.098 <u>+</u> 0.004

0.022 ± 0.004

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mm

2.0 ± 0.1

2.5 <u>+</u> 0.1

0.55 <u>+</u> 0.1

0.55

0.1

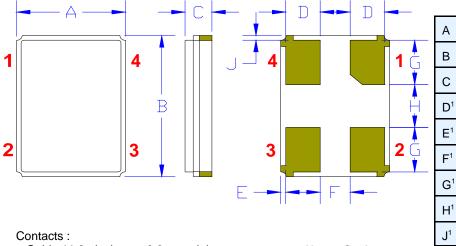
0.7

0.7

0.9

0.1

Mechanical:

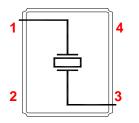


Gold 11.8 µinches 0.3 µm minimum over Nickel 50 to 350 µinches 1.27 to 8.89 µm

Not to 3	Scale
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¹ Typical dimensions

Connection (top view):



Pad 2 and Pad 4 are common and connected to the metal cover. They are not connected to the crystal.



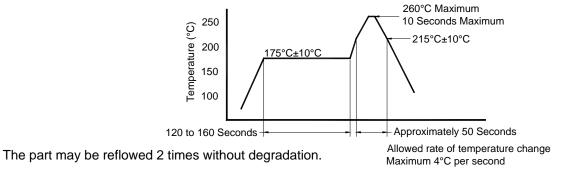
Layout and application information

- Trace lengths to the crystal should be kept as short as possible.
- The crystal connections are sensitive to noise.
- The package should be grounded for optimum performance, pad 2 and/or pad 4 connected to ground.



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Reflow Cycle (typical for lead free processing)



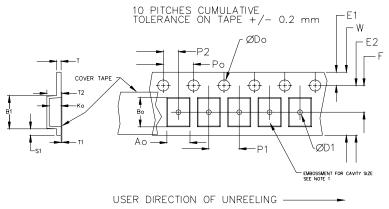
Tape and Reel: available for quantities of 250 to 3000 per reel (<1000 will be cut tape)

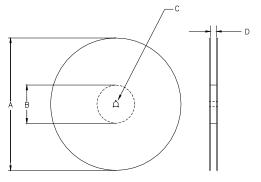
Not to scale

	Constant Dimensions Table 1									
Tape Size	D0	D1 Min	E1	P0	P2	S1 Min	T Max	T1 Max		
8mm		1.0			2.0					
12mm	1.5	1.5	1.75	4.0	<u>+</u> 0.05					
16mm	+0.1 -0.0	1.5	<u>+</u> 0.1	<u>+</u> 0.1	2.0	0.6	0.25	0.1		
24mm		1.5			<u>+</u> 0.1					

	Variable Dimensions Table 2								
Tape Size	B1 Max	E2 Min	F	P1	T2 Max	W Max	Ao, Bo & Ko		
8 mm	3.5	6.4	1.7 <u>+</u> 0.1	4.0 <u>+</u> 0.1	1.0	8.9	Note 1		

Note 1: Embossed cavity to conform to EIA-481-B Dimensions in mm





		REE	L DIMENSI	ONS	
А	inches	7.0	10.0	13.0	
	mm	177.8	254.0	330.2	
в	inches	2.50	4.00	3.75	
	mm	63.5	101.6	95.3	Tape Width
с	mm	13	3.0 +0.5 / -0.	.2	Widui
D	mm	8.4 +2.0 -0.0	8.4 +2.0 -0.0	8.4 +2.0 -0.0	8.0

Reel dimensions may vary from the above



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